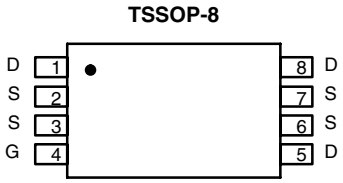
N-Channel 2.5-V (G-S) MOSFET

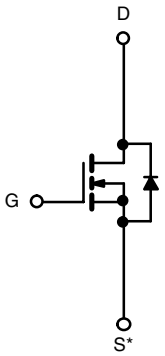
PRODUCT SUMMARY		
V_{DS} (V)	$R_{DS(on)}$ (Ω)	I_D (A)
20	0.014 at V_{GS} = 4.5 V	8.1
	0.020 at V_{GS} = 2.5 V	6.6

FEATURES

- **Halogen-free**
- TrenchFET® Power MOSFETs
- 100 % R_g Tested

Pb-free
RoHS COMPLIANT





* Source Pins 2, 3, 6 and 7 must be tied common.

Ordering Information: Si6466ADQ-T1-GE3 (Lead (Pb)-free and Halogen-free)

N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T_A = 25 °C, unless otherwise noted					
Parameter		**Symbol**	**10 s**	**Steady State**	**Unit**
Drain-Source Voltage		V_{DS}	20		V
Gate-Source Voltage		V_{GS}	± 8		
Continuous Drain Current (T_J = 150 °C)[a]	T_A = 25 °C	I_D	8.1	6.8	A
	T_A = 70 °C		6.6	5.4	
Pulsed Drain Current (10 µs Pulse Width)		I_{DM}	30		
Continuous Source Current (Diode Conduction)[a]		I_S	1.35	0.95	
Maximum Power Dissipation[a]	T_A = 25 °C	P_D	1.5	1.05	W
	T_A = 70 °C		1.0	0.67	
Operating Junction and Storage Temperature Range		T_J, T_{stg}	- 55 to 150		°C

THERMAL RESISTANCE RATINGS					
Parameter		**Symbol**	**Typical**	**Maximum**	**Unit**
Maximum Junction-to-Ambient[a]	t ≤ 10 s	R_{thJA}	65	83	°C/W
	Steady State		100	120	
Maximum Junction-to-Foot	Steady State	R_{thJF}	43	52	

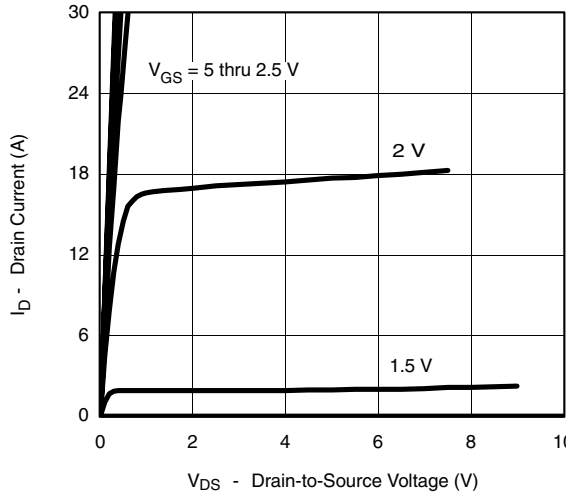
Notes:
a. Surface Mounted on 1" x 1" FR4 board.

SPECIFICATIONS T_J = 25 °C, unless otherwise noted						
Parameter	**Symbol**	**Test Conditions**	**Min.**	**Typ.**	**Max.**	**Unit**
Static						
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250 µA	0.45			V
Gate-Body Leakage	I_{GSS}	V_{DS} = 0 V, V_{GS} = ± 8 V			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = 16 V, V_{GS} = 0 V			1	µA
		V_{DS} = 16 V, V_{GS} = 0 V, T_J = 70 °C			10	
On-State Drain Current[a]	$I_{D(on)}$	V_{DS} = 5 V, V_{GS} = 4.5 V	20			A
Drain-Source On-State Resistance[a]	$R_{DS(on)}$	V_{GS} = 4.5 V, I_D = 8.1 A		0.011	0.014	Ω
		V_{GS} = 2.5 V, I_D = 6.6 A		0.017	0.020	
Forward Transconductance[a]	g_{fs}	V_{DS} = 10 V, I_D = 8.1 A		30		S
Diode Forward Voltage[a]	V_{SD}	I_S = 1.35 A, V_{GS} = 0 V		0.65	1.1	V
Dynamic[b]						
Total Gate Charge	Q_g	V_{DS} = 10 V, V_{GS} = 5 V, I_D = 8.1 A		18	27	nC
Gate-Source Charge	Q_{gs}			3.2		
Gate-Drain Charge	Q_{gd}			4		
Gate Resistance	R_g		0.5		1.8	Ω
Turn-On Delay Time	$t_{d(on)}$	V_{DD} = 10 V, R_L = 10 Ω I_D ≅ 1 A, V_{GEN} = 4.5 V, R_G = 6 Ω		27	45	ns
Rise Time	t_r			34	50	
Turn-Off Delay Time	$t_{d(off)}$			76	120	
Fall Time	t_f			30	50	
Source-Drain Reverse Recovery Time	t_{rr}	I_F = 1.5 A, di/dt = 100 A/µs		35	70	

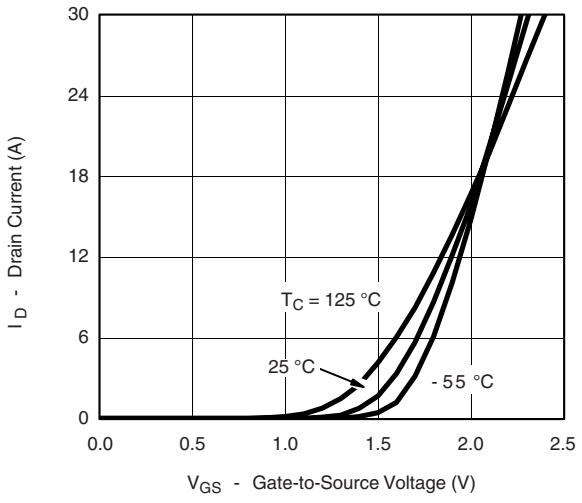
Notes:
a. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %.
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

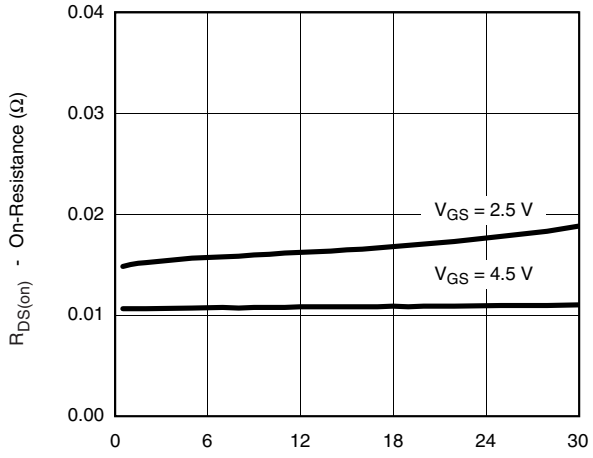


Output Characteristics

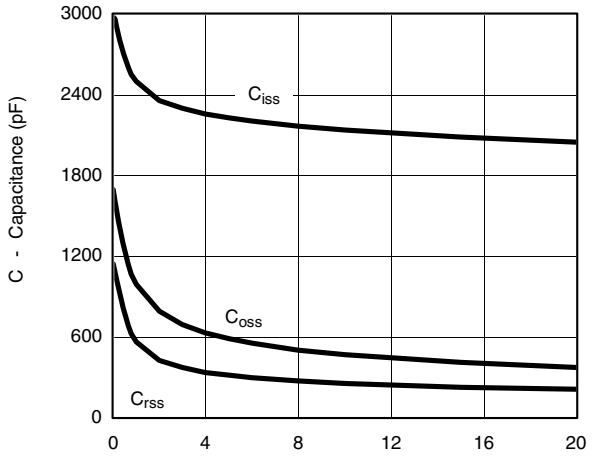


Transfer Characteristics

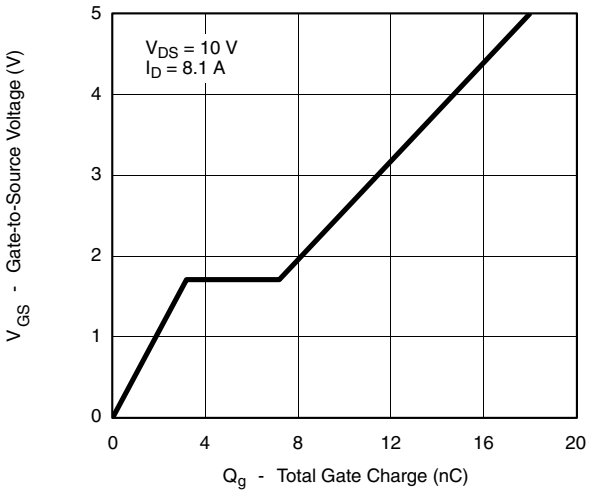
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



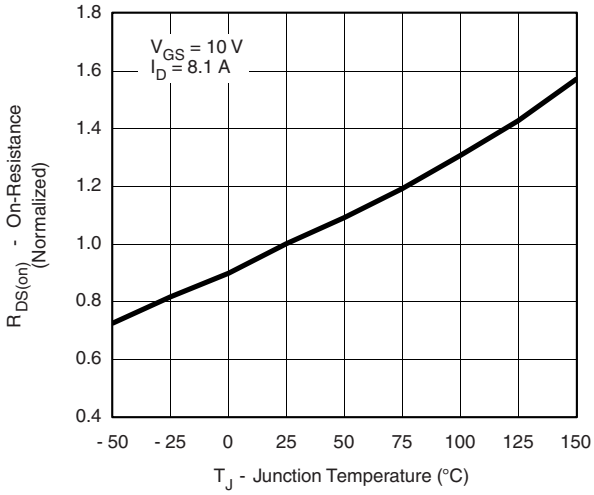
On-Resistance vs. Drain Current



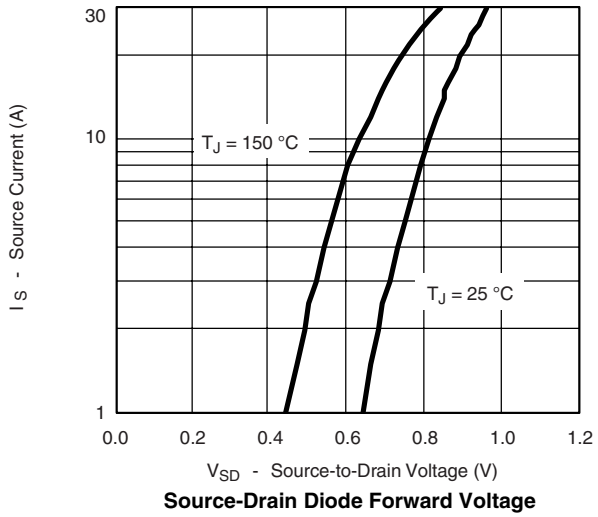
Capacitance



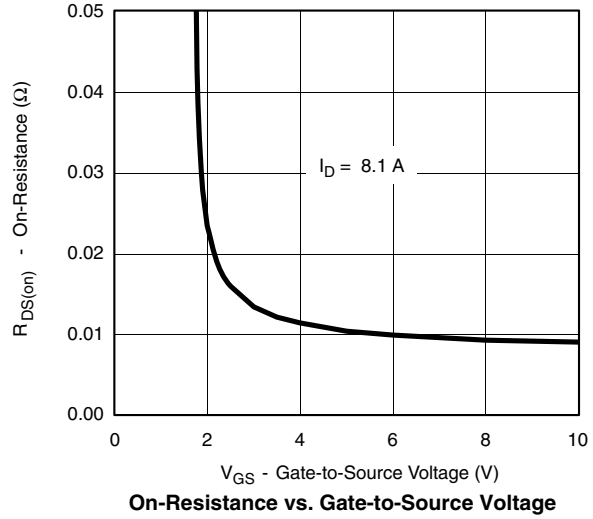
Gate Charge



On-Resistance vs. Junction Temperature

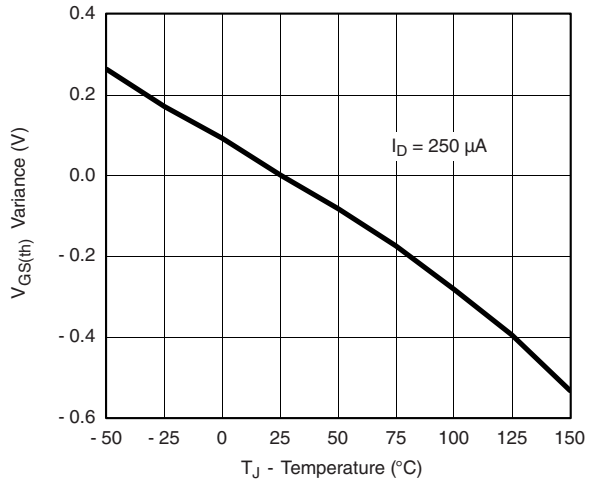


Source-Drain Diode Forward Voltage

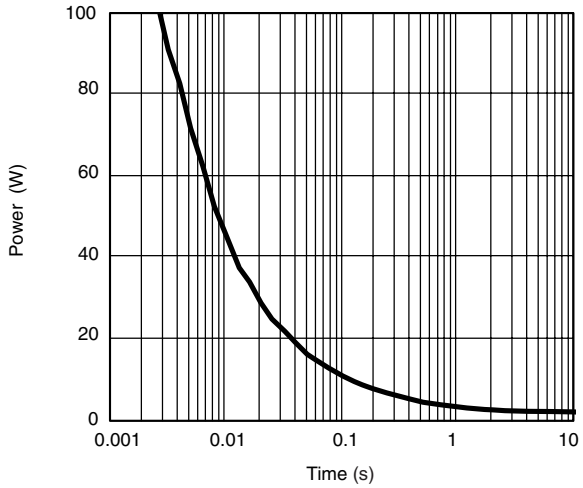


On-Resistance vs. Gate-to-Source Voltage

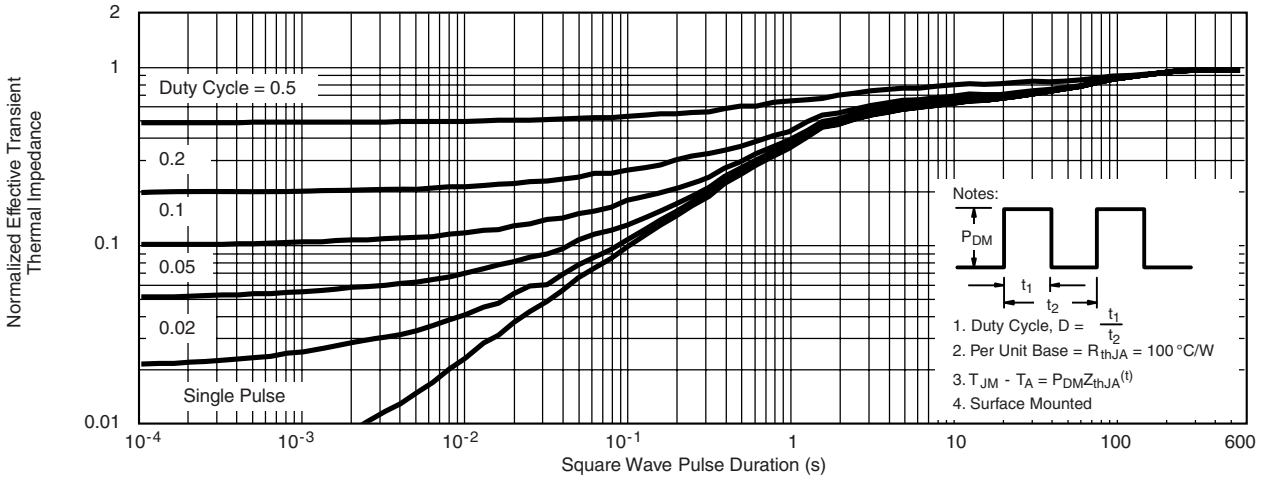
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



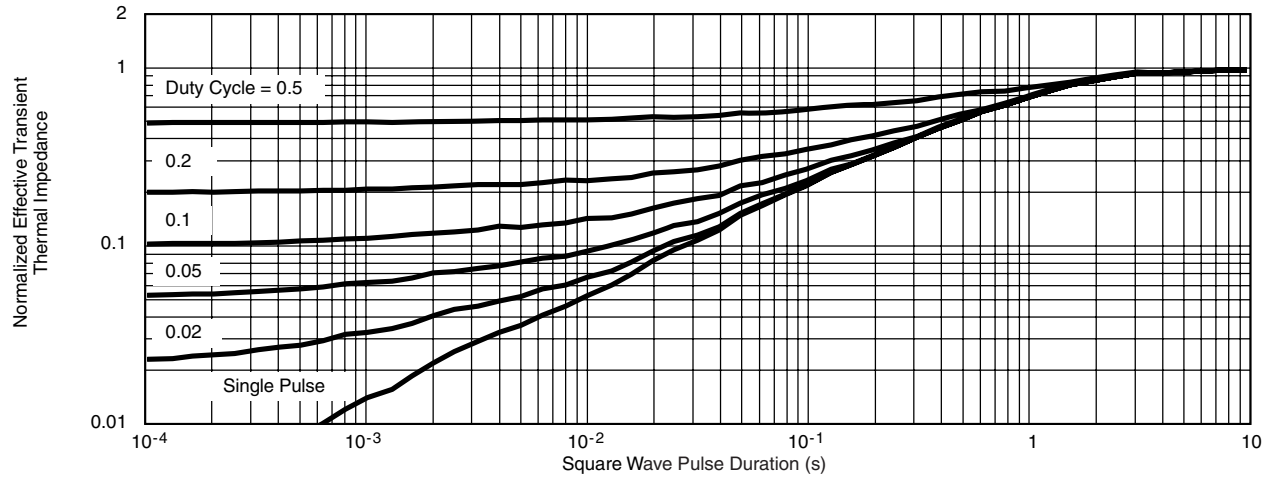
Threshold Voltage



Single Pulse Power, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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